

APPLICATIONS



- Battery-powered devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 5.5mmx5.3mmx2.9mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

Parameter			Value	Unit
Inductance ⁽¹⁾	L	±20%	3.3	μH
Resistance	R_{DC}	typ	21	mΩ
Resistance _{MAX}	$R_{DC\ MAX}$	max	23.5	mΩ
Rated Current ⁽²⁾	I_R	typ	6.0	A
Saturation Current _{25°C} ⁽³⁾	$I_{SAT\ 25°C}$	typ	10	A
Saturation Current _{100°C} ⁽⁴⁾	$I_{SAT\ 100°C}$	typ	10	A
Resonance Frequency	f_r	typ	30	MHz

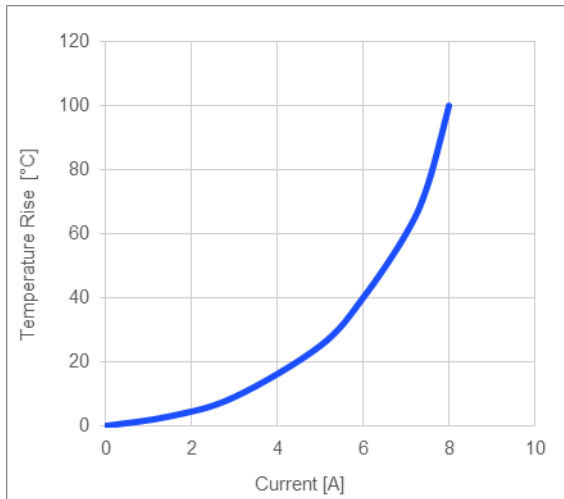
GENERAL SPECIFICATIONS

⁽¹⁾ Inductance	Measured at 100kHz, 100mA
⁽²⁾ Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
⁽³⁾ Saturation Current _{25°C}	Saturation current will cause L to drop from 30% at 25°C ambient temperature
⁽⁴⁾ Saturation Current _{100°C}	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise) Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

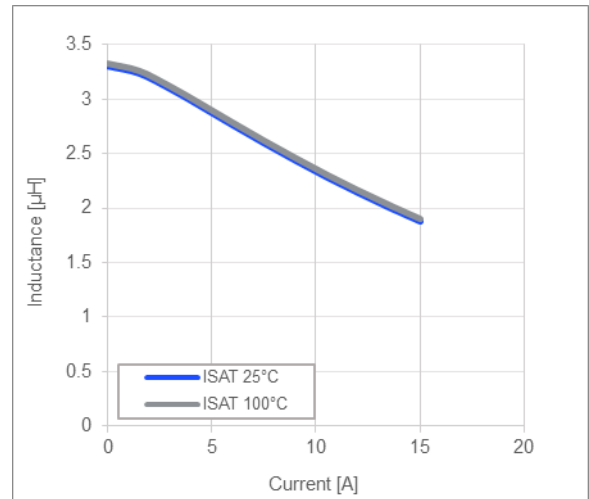
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TYPICAL PERFORMANCE CURVES

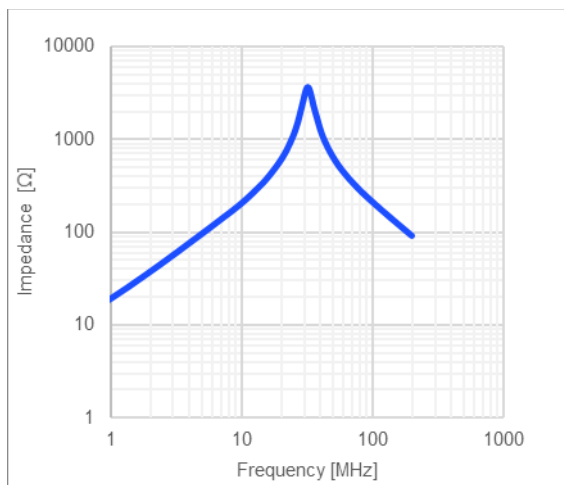
Temperature Rise vs. Current



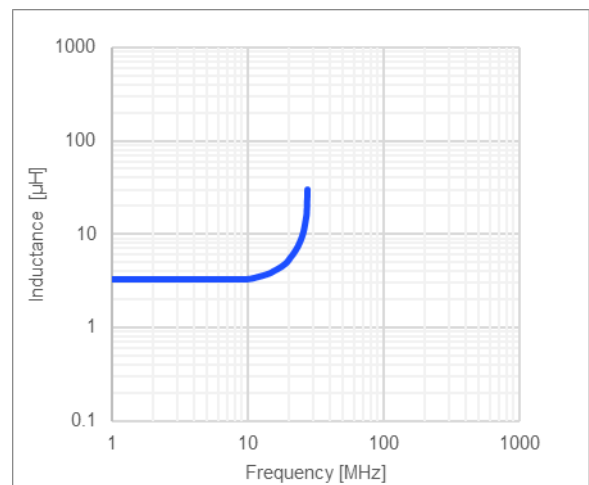
Inductance vs. Current



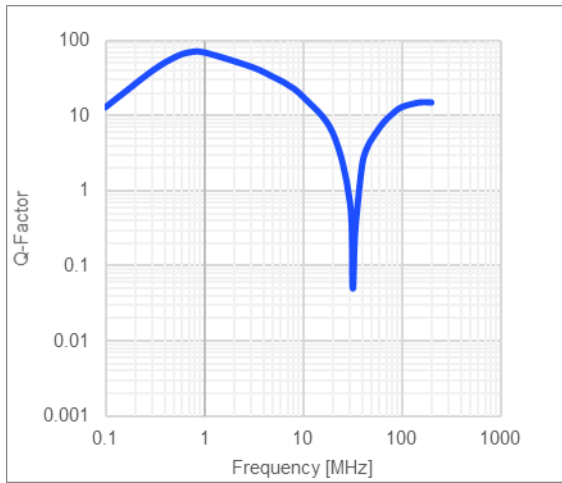
Impedance vs. Frequency



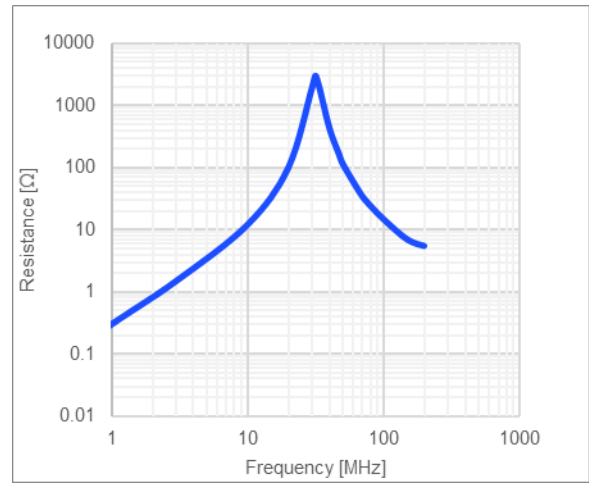
Inductance vs. Frequency



Quality Factor vs. Frequency



AC Resistance vs. Frequency



LAND PATTERN

Dimensions

A	4.70 ref.
B	2.0 ref.
C	4.50 ref.

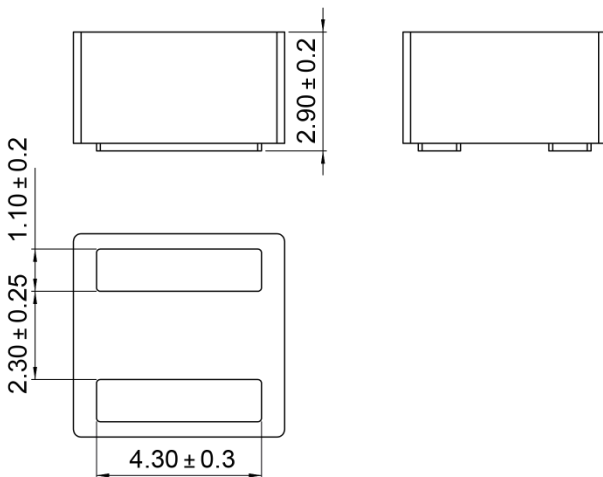
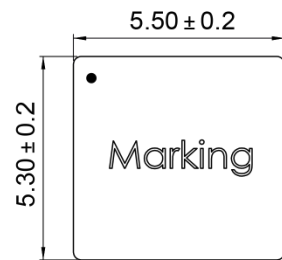
(unit in mm)



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING

Marking

Start of Winding	· (dot)
Inductance Code	3R3
MPS Code	MPS

ORDERING INFORMATION

Part Number	L ⁽¹⁾	R_{DC}	I_R ⁽²⁾	$I_{SAT 25^\circ C}$ ⁽³⁾	$I_{SAT 100^\circ C}$ ⁽⁴⁾
	typ (μ H)	typ (m Ω)	typ (A)	typ (A)	typ (A)
MPL-AL5030-R47	0.47	3.78	13.6	26.5	26.5
MPL-AL5030-R56	0.56	3.92	13.2	22	22
MPL-AL5030-R82	0.82	5.0	12.8	18	18
MPL-AL5030-1R0	1.0	6.5	11.2	16	16
MPL-AL5030-1R2	1.2	8.0	10.0	14	14
MPL-AL5030-1R5	1.5	9.7	9.0	12.5	12.5
MPL-AL5030-1R8	1.8	10.5	8.8	12	12
MPL-AL5030-2R2	2.2	12.3	8.2	11	11
MPL-AL5030-3R3	3.3	21	6.0	10	10
MPL-AL5030-4R7	4.7	33	5.3	8	8

GENERAL SPECIFICATIONS

(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K <i>I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.</i>
(3) Saturation Current $_{25^\circ C}$	Saturation current will cause L to drop from 30% at 25 $^\circ$ C ambient temperature
(4) Saturation Current $_{100^\circ C}$	Saturation current will cause L to drop from 30% at 100 $^\circ$ C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25 $^\circ$ C, 35% RH if not given differently
Operating Condition	Operating temperature: -40 $^\circ$ C to +155 $^\circ$ C (including temp rise) Should not exceed +155 $^\circ$ C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10 $^\circ$ C to +40 $^\circ$ C Humidity: <50% RH

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